

## **DATASHEET**

# 4 PIN DIP PHOTOTRANSISTOR PHOTOCOUPLER EL817-G Series



#### Features:

- Compliance Halogens Free (Br < 900 ppm, Cl < 900 ppm, Br+Cl < 1500 ppm)
- Current transfer ratio
  (CTR: 50~600% at IF = 5mA, VcE = 5V)
  High isolation voltage between input
- High isolation voltage between input and output (Viso = 5000Vrms)
- Creepage distance > 7.62mm
- Operating temperature up to +110°C
- Compact small outline package
- Compliance with EU REACH.
- •The product itself will remain within RoHS compliant version
- UL and cUL approved(No.E214129)
- VDE approved (No.132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CQC approved

## **Description**

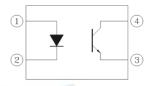
The EL817-G series of devices each consist of an infrared emitting diodes, optically coupled to a phototransistor detector.

They are packaged in a 4-pin DIP package and available in wide-lead spacing and SMD option.

## **Applications**

- Programmable controllers
- System appliances, measuring instruments
- Telecommunication equipments
- Home appliances, such as fan heaters, etc.
- Signal transmission between circuits of different potentials and impedances

## <u>Schematic</u>



## Pin Configuration

- 1. Anode
- 2. Cathode
- 3. Emitter
- 4. Collector



## **Absolute Maximum Ratings (Ta=25°C)**

	Parameter	Symbol	Rating	Unit
	Forward current	I <sub>F</sub>	60	mA
	Peak forward current (1us, pulse)	I <sub>FP</sub>	1	А
Input	Reverse voltage	V <sub>R</sub>	6	V
	Power dissipation	D	100	mW
	Derating factor (above T <sub>a</sub> = 100°C)	$P_{D}$	2.9	mW/°C
	Power dissipation	D	150	mW
	Derating factor (above T <sub>a</sub> = 100°C)	P <sub>C</sub>	5.8	mW/°C
Output	Collector current	I <sub>C</sub>	50	mA
	Collector-Emitter voltage	V <sub>CEO</sub>	80	V
	Emitter-Collector voltage	$V_{\text{ECO}}$	7	V
Total Powe	r Dissipation	P <sub>TOT</sub>	200	mW
Isolation Vo	oltage* <sup>1</sup>	V <sub>ISO</sub>	5000	V rms
Operating	Temperature	T <sub>OPR</sub>	-55 to 110	°C
Storage Te	mperature	T <sub>STG</sub>	-55 to 125	°C
Soldering 7	Femperature*2	T <sub>SOL</sub>	260	°C
Soldering 7	Temperature* <sup>2</sup>	T <sub>SOL</sub>	260	°C

## Notes:

<sup>\*1</sup> AC for 1 minute, R.H.=  $40 \sim 60\%$  R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together.

<sup>\*2</sup> For 10 seconds



## Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

Input

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	$V_{F}$	-	1.2	1.4	V	$I_F = 20 \text{mA}$
Reverse Current	I <sub>R</sub>	-	-	10	μA	$V_R = 4V$
Input capacitance	C <sub>in</sub>	-	30	250	pF	V = 0, $f = 1kHz$

Output

Parameter	Symbol	Min	Тур.	Max.	Unit	Condition	
Collector-Emitter dark	lana	_	_	100	nA	$V_{CE} = 20V, I_{F} = 0mA$	
current	ICEO			100	11/3	VCE = 20 V, IF = 0111A	
Collector-Emitter	$BV_CEO$	80	_	_	V	$I_{\rm C} = 0.1  \rm mA$	
breakdown voltage	PACEO	00			V	IC = 0. IIIIA	
Emitter-Collector	D\/	7	_	_	V	L = 0.1mΛ	
breakdown voltage	$BV_{ECO}$	1	-	-	V	$I_E = 0.1 \text{mA}$	

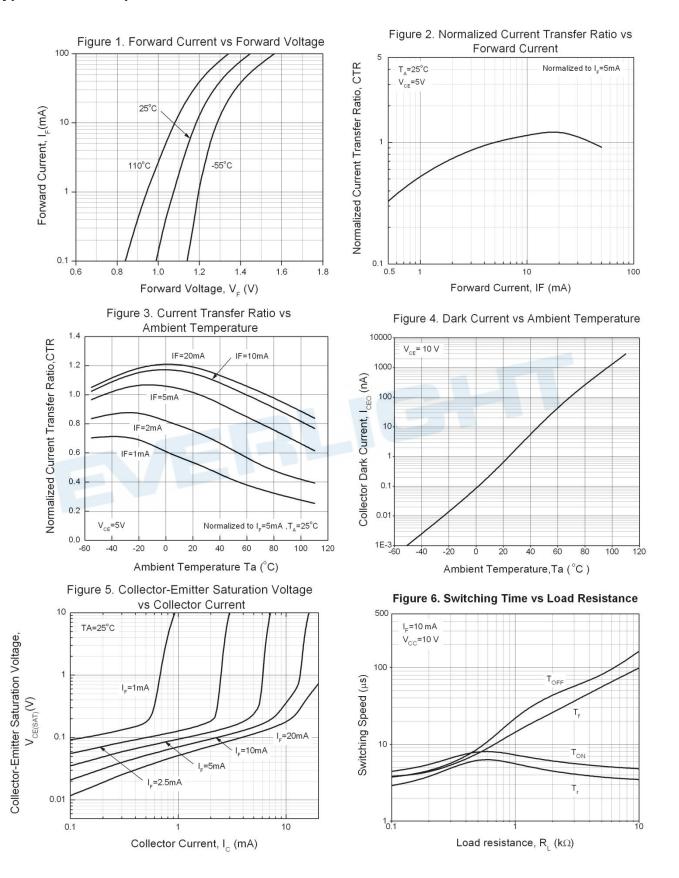
**Transfer Characteristics** 

Para	meter	Symbol	Min	Тур.	Max.	Unit	Condition
Current	EL817	<b>/</b> E	50		600		I <sub>F</sub> = 5mA ,V <sub>CE</sub> = 5V
	EL817A		80	<u>-</u>	160		
	EL817B		130	-	260	%	
Transfer	EL817C	CTR	200	-	400		
ratio	EL817D		300	-	600		
	EL817X		100	-	200		
	EL817Y		150	-	300		
Collector-Emitter saturation voltage		$V_{\text{CE(sat)}}$	-	0.1	0.2	V	$I_F = 20\text{mA}$ , $I_C = 1\text{mA}$
Isolation re	sistance	R <sub>IO</sub>	5×10 <sup>10</sup>	-	-	Ω	V <sub>IO</sub> = 500Vdc, 40~60% R.H.
Floating ca	pacitance	$C_IO$	-	0.6	1.0	pF	$V_{IO} = 0$ , $f = 1MHz$
Cut-off frequency		fc	-	80	-	kHz	$V_{CE} = 5V$ , $I_C = 2mA$ $R_L = 100\Omega$ , $-3dB$
Rise time		$t_r$	-	6	18	μs	$V_{CE} = 2V, I_{C} = 2mA,$
Fall time		t <sub>f</sub>	-	8	18	μs	$R_L = 100\Omega$

<sup>\*</sup> Typical values at T<sub>a</sub> = 25°C



## **Typical Electro-Optical Characteristics Curves**





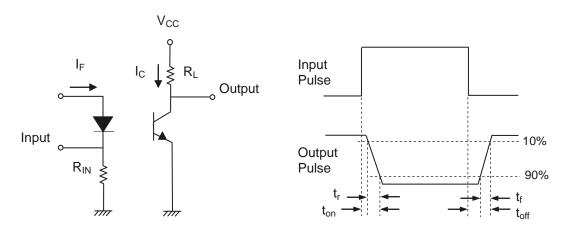


Figure 7. Switching Time Test Circuit & Waveforms





## **Order Information**

## **Part Number**

## EL817X(Y)(Z)-FVG

#### Note

X = Lead form option (S1, S2, M or none) Y = CTR Rank (A, B, C, D, X, Y or none)

Z = Tape and reel option (TU, TD or none)

F = Lead frame option (F: Iron, None: copper)

V = VDE safety (optional)

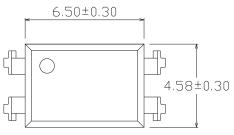
G = Halogens free

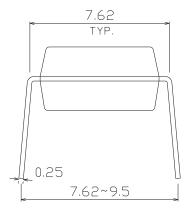
Option	Description	Packing quantity
None	Standard DIP-4	100 units per tube
М	Wide lead bend (0.4 inch spacing)	100 units per tube
S1 (TU)	Surface mount lead form (low profile) + TU tape & reel option	1500 units per reel
S1 (TD)	Surface mount lead form (low profile) + TD tape & reel option	1500 units per reel
S2 (TU)	Surface mount lead form (low profile) + TU tape & reel option	2000 units per reel
S2 (TD)	Surface mount lead form (low profile) + TD tape & reel option	2000 units per reel

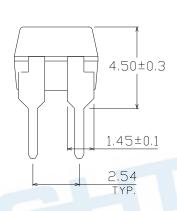


## Package Dimension (Dimensions in mm)

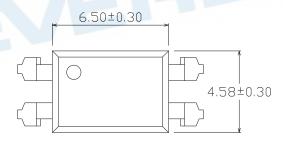
## **Standard DIP Type**

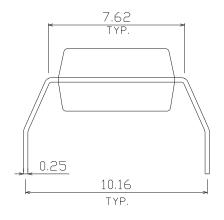


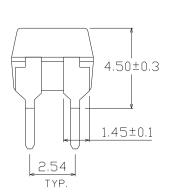




## **Option M Type**

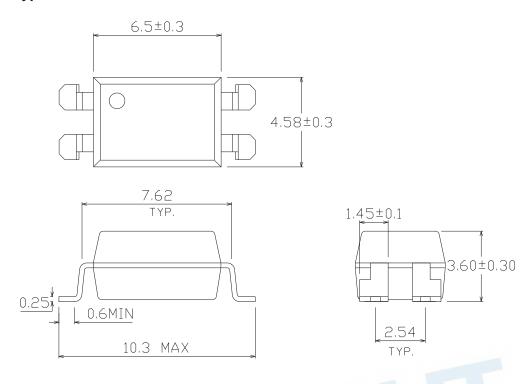




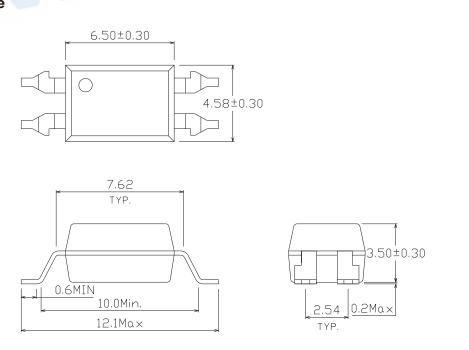




## **Option S1 Type**



## **Option S2 Type**

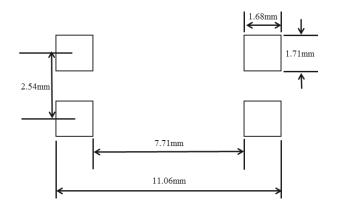


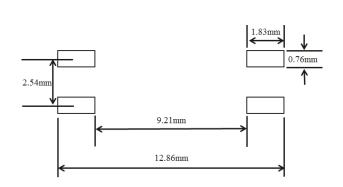


## Recommended pad layout for surface mount leadform

## For S1 option

## For S2 option





#### **Notes**

Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

## **Device Marking**



#### **Notes**

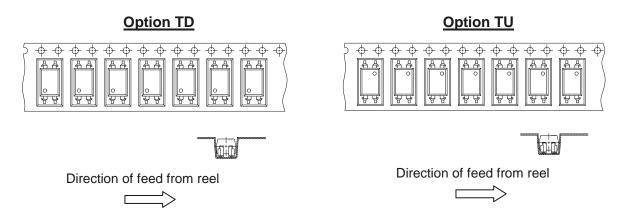
EL	denotes EVERLIGHT
817	denotes Device Number

F denotes Factory Code (G: China and Green part)
R denotes CTR Rank (A, B, C, D, X, Y or none)

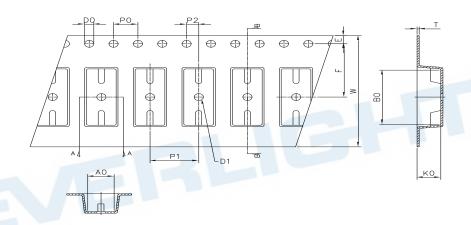
Y denotes 1 digit Year code WW denotes 2 digit Week code V denotes VDE (optional)



**Tape & Reel Packing Specifications** 



## **Tape dimensions**



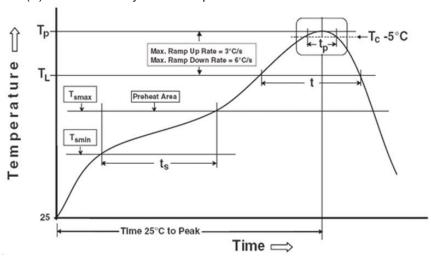
Dimension No.	Ao	Во	Do	D1	E	F
Dimension (mm) S1	4.90±0.1	10.40±0.1	1.5±0.1	1.50±0.1	1.75±0.1	7.50±0.1
Dimension (mm) S2	4.88±0.1	12.55±0.1	1.5±0.1	1.50±0.1	1.75±0.1	11.5±0.1
Dimension No.	Ро	P1	P2	t	w	Ко
Dimension No.  Dimension (mm) S1	Po 4.00±0.1	P1 8.00±0.1	P2 2.00±0.1	t 0.40±0.1	W 16.00±0.3	<b>Ko</b> 4.60±0.1



## **Precautions for Use**

#### 1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

#### **Preheat**

Temperature min (T<sub>smin</sub>)

Temperature max (T<sub>smax</sub>)

Time  $(T_{smin} \text{ to } T_{smax})$   $(t_s)$ 

Average ramp-up rate (T<sub>smax</sub> to T<sub>p</sub>)

#### Other

Liquidus Temperature (T<sub>L</sub>)

Time above Liquidus Temperature (t L)

Peak Temperature (T<sub>P</sub>)

Time within 5 °C of Actual Peak Temperature: T<sub>P</sub> - 5°C

Ramp- Down Rate from Peak Temperature

Time 25°C to peak temperature

Reflow times

Reference: IPC/JEDEC J-STD-020D

150 °C

200°C

60-120 seconds

3 °C/second max

217 °C

60-100 sec

260°C

30 s

6°C /second max.

8 minutes max.

3 times



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